

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT6882303

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEI LIU	07/15/2021
MR. KUN ZHOU	07/15/2021
RECEIVING PARTY DATA	
Name:	SIEMENS SHENZHEN MAGNETIC RESONANCE LTD.
Street Address:	GAO XIN ZHONG ER DAO, GAO XIN QU, ZHONG QU
City:	SHENZHEN
State/Country:	CHINA
Postal Code:	518057
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17348927
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	(312) 258-5500
Email:	patents-ch@schiffhardin.com
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Address Line 2:	SUITE 7100
Address Line 4:	CHICAGO, ILLINOIS 60606
ATTORNEY DOCKET NUMBER:	26965-6183 P210049
NAME OF SUBMITTER:	SHAWN M. BUCHANAN
SIGNATURE:	/Shawn M. Buchanan/
DATE SIGNED:	08/25/2021
Total Attachments: 3	
source=P210049 Assignment inventors to SSMR Ltd#page1.tif	
source=P210049 Assignment inventors to SSMR Ltd#page2.tif	
source=P210049 Assignment inventors to SSMR Ltd#page3.tif	

ASSIGNMENT

For good and valuable consideration, I (We),

Wei Liu, residing at Guanminhuayuan 1-1909, Nanshan District, Shenzhen, China 518100, CN,
citizen of CN

Kun Zhou, residing at Gaoxin C. Ave., 2nd, Hi-Tech Industrial Park, Shenzhen, 518057, CN,
citizen of CN

hereafter individually or collectively referred to as "Assignor(s)"; hereby

- (1) (A) acknowledge having previously assigned, sold and transferred to **Siemens Shenzhen Magnetic Resonance Ltd.**, a corporation organized and existing under the laws of CHINA, having its principal place of business at Gao Xin Zhong Er Dao, Gao Xin Qu, Zhong Qu, Shenzhen 518057, hereinafter "Assignee", its successors, assigns and legal representatives, or to a predecessor of Assignee, pursuant to

(i) the laws of CHINA or
(ii) a Patent & Secrecy Agreement or similar legal document such as, without limitation, an employee agreement executed at the time of entering into the employment of, or executed as a condition of continuing employment with, the Assignee or a predecessor of the Assignee, the entire right, including any and all priority rights, title and interest, in and for the United States and all foreign countries, in and to any and all inventions or improvements which are disclosed in an invention disclosure and/or in the below-identified documents currently filed with this Assignment, already filed or granted for Letters Patent (in which case, if any provision of the subject Assignment that is in conflict with or is in addition to any provision in the prior agreement(s) or assignment(s) then this Assignment shall govern, take precedence, and be of legal effect), or

- (B) (i) to the extent such laws of CHINA or such Patent & Secrecy Agreement or similar legal document failed or fails, in whole or part, to have assigned, sold or transferred the entire right (including priority rights), title and interest, in and for the United States and all foreign countries, in and to all inventions or improvements which are disclosed in the below-identified application(s) or pending application(s) or granted Letters Patent, or
(ii) if no such agreement(s) exist assigning, selling or transferring any such right (including priority rights), title or interest;

then for good and valuable consideration, Assignor(s) now and hereby, effective Nunc Pro Tunc on the filing date of the below identified patent application(s), pending patent application(s) or granted Letter Patent(s), assign, sell and transfer(s) to Assignee, its successors, assigns and legal representatives,

(i) the entire right, (including all priority rights), title and interest in and for the United States and all foreign countries, in and to any and all inventions and/or improvements which are disclosed in the following identified; patent application(s), pending patent application(s) or granted Letter Patent(s). I/we hereby authorize the Assignee or its designee to insert below the information when known

Patent Application Title: 3D FLOW COMPENSATED INTERLEAVED EPI IN
COMBINED WITH SWAPPED READOUT

Filing Date: 16 Jun 2021

Filing Number: 17/348,927

Internal Case Number(s): 2020P08597 US

and

(ii) in and to said application(s) or granted patents and all applications claiming priority to said application or granted patent, including, without limitation, all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of the inventions and/or improvements; and

(iii) in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on the inventions and/or improvements;

- (2) agree that said Assignee may apply for and receive Letters Patent for said inventions and/or improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said inventions and/or improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said inventions and/or improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and/or improvements and for vesting title to said inventions and/or improvements and all applications for patents and all patents on said inventions and/or improvements, in said Assignee, its successors, assigns and legal representatives; and
- (3) covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Wei Liu

Wei Liu

July 15, 2021

Date

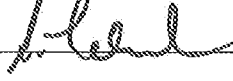
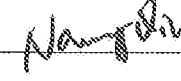
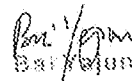
Kun Zhou

Kun Zhou

July 15, 2021

Date

Companies Representative(s)
Siemens Shenzhen Magnetic Resonance Ltd.

Signature(s)			
Name(s)	Schneck, Andreas	Qiu Yan Hua	Bai Ya Jun
Title	SSMR General Manager	SSMR Vice President of Finance	Head of IP China
Date	21 JUL 2021	19 JUL 2021	